

STN	Normalizácia rozmerov polovodičových súčiastok Časť 4: Systém kódovania a triedenia podľa tvaru puzdier polovodičových súčiastok Zmena A1	STN EN 60191-4/A1 35 8791
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Táto norma obsahuje anglickú verziu európskej normy.
This standard includes the English version of the European Standard.

Táto norma bola oznámená vo Vestníku ÚNMS SR č. 01/19

STN EN 60191-4 zo septembra 2014 sa bez tejto zmeny A1 môže používať do 1. 5. 2021.

Obsahuje: EN 60191-4:2014/A1:2018, IEC 60191-4:2013/AMD1:2018

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EUROPEAN STANDARD

EN 60191-4:2014/A1

NORME EUROPÉENNE

EUROPÄISCHE NORM

May 2018

ICS 31.080

English Version

**Mechanical standardization of semiconductor devices - Part 4:
Coding system and classification into forms of package outlines
for semiconductor device packages
(IEC 60191-4:2013/A1:2018)**

Normalisation mécanique des dispositifs à semiconducteurs
- Partie 4: Système de codification et classification en
formes des structures des boîtiers pour dispositifs à
semiconducteurs
(IEC 60191-4:2013/A1:2018)

Mechanische Normung von Halbleiterbauelementen - Teil
4: Codierungssystem für Gehäuse und Eingruppierung der
Gehäuse nach der Gehäuseform für Halbleiterbauelemente
(IEC 60191-4:2013/A1:2018)

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European Committee for Electrotechnical Standardization
Comité Européen de Normalisation Electrotechnique
Europäisches Komitee für Elektrotechnische Normung

CEN-CENELEC Management Centre: Rue de la Science 23, B-1040 Brussels

EN 60191-4:2014/A1:2018 (E)**European foreword**

The text of document 47D/897/CDV, future edition 3 of IEC 60191-4:2013/A1, prepared by IEC/TC 47D "Semiconductor devices packaging, of IEC technical committee 47: Semiconductor devices" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN 60191-4:2014/A1:2018.

The following dates are fixed:

- latest date by which the document has to be implemented at national level by publication of an identical national standard or by endorsement (dop) 2019-02-01
- latest date by which the national standards conflicting with the document have to be withdrawn (dow) 2021-05-01

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IEC 60191-4

Edition 3.0 2018-03

INTERNATIONAL STANDARD

NORME INTERNATIONALE

AMENDMENT 1
AMENDEMENT 1

**Mechanical standardization of semiconductor devices –
Part 4: Coding system and classification into forms of package outlines for
semiconductor device packages**

**Normalisation mécanique des dispositifs à semiconducteurs –
Partie 4: Système de codification et classification en formes des structures des
boîtiers pour dispositifs à semiconducteurs**



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FOREWORD

This amendment has been prepared by subcommittee 47D: Semiconductor devices packaging, of IEC technical committee 47: Semiconductor devices.

The text of this amendment is based on the following documents:

CDV	Report on voting
47D/897/CDV	47D/904/RVC

Full information on the voting for the approval of this amendment can be found in the report on voting indicated in the above table.

The committee has decided that the contents of this amendment and the base publication will remain unchanged until the stability date indicated on the IEC website under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

Add, after Annexes A and B, the following new Annex C:

koniec náhľadu – text ďalej pokračuje v platenej verzii STN